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MOSFET – Power, N-Channel, SOT-23 200 mA, 50 V

BSS138L, BVSS138L

Typical applications are DC-DC converters, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

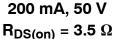
Features

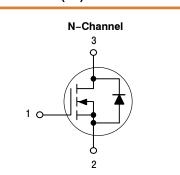
- Low Threshold Voltage (V_{GS(th)}: 0.85 V-1.5 V) Makes it Ideal for Low Voltage Applications
- Miniature SOT-23 Surface Mount Package Saves Board Space
- HBM Class 0A, MM Class M1A, CDM Class IV (Note 3)
- BVSS Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

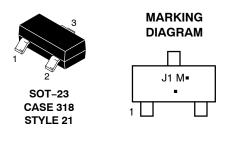
MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Value	Unit
V_{DSS}	50	Vdc
V_{GS}	± 20	Vdc
I _D I _{DM}	200 800	mA
PD	225	mW
T _J , T _{stg}	– 55 to 150	°C
$R_{\theta JA}$	556	°C/W
ΤL	260	°C
	V _{DSS} V _{GS} I _D I _{DM} P _D T _J , T _{stg} R _{θJA}	$\begin{tabular}{ c c c c } \hline V_{DSS} & 50 \\ \hline V_{GS} & \pm 20 \\ \hline I_D & 200 \\ \hline I_{DM} & 800 \\ \hline P_D & 225 \\ \hline T_J, T_{stg} & -55 \ to \ 150 \\ \hline R_{\theta,JA} & 556 \\ \hline \end{tabular}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







J1 = Device Code М

= Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
BSS138LT1G, BVSS138LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel
BSS138LT7G	SOT-23 (Pb-Free)	3,500 / Tape & Reel
BSS138LT3G, BVSS138LT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Char	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage (V_{GS} = 0 Vdc, I_D = 250 μ Adc)	9	V _{(BR)DSS}	50	-	-	Vdc
$\label{eq:VDS} \begin{array}{l} \mbox{Zero Gate Voltage Drain Current} \\ (V_{DS} = 25 \mbox{ Vdc}, V_{GS} = 0 \mbox{ Vdc}, 25 \mbox{°C} \\ (V_{DS} = 50 \mbox{ Vdc}, V_{GS} = 0 \mbox{ Vdc}, 25 \mbox{°C} \\ (V_{DS} = 50 \mbox{ Vdc}, V_{GS} = 0 \mbox{ Vdc}, 150 \mbox{°C} \end{array}$))	I _{DSS}	- - -	- - -	0.1 0.5 5.0	μAdc
Gate-Source Leakage Current (V _{GS}	I _{GSS}	-	_	±0.1	μAdc	
ON CHARACTERISTICS (Note 1)						
Gate-Source Threshold Voltage $(V_{DS} = V_{GS}, I_D = 1.0 \text{ mAdc})$		V _{GS(th)}	0.85	-	1.5	Vdc
Static Drain-to-Source On-Resistance ($V_{GS} = 2.75$ Vdc, $I_D < 200$ mAdc, $T_A = -40^{\circ}C$ to +85°C) ($V_{GS} = 5.0$ Vdc, $I_D = 200$ mAdc)		r _{DS(on)}		5.6 -	10 3.5	Ω
Forward Transconductance $(V_{DS} = 25 \text{ Vdc}, I_D = 200 \text{ mAdc}, f = 1.0 \text{ kHz})$		9 _{fs}	100	-	-	mmhos
DYNAMIC CHARACTERISTICS		•	-			•
Input Capacitance	$(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$	C _{iss}	-	40	50	pF

Output Capacitance	$(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$	C _{oss}	-	12	25		
Transfer Capacitance	$(V_{DG} = 25 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$	C _{rss}	-	3.5	5.0		
SWITCHING CHARACTERISTICS (Note 2)							

Turn-On Delay Time	(V _{DD} = 30 Vdc, I _D = 0.2 Adc,)	t _{d(on)}	-	-	20	ns
Turn-Off Delay Time	(VDD - 30 Vdc, ID - 0.2 Adc,)	t _{d(off)}	-	-	20	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

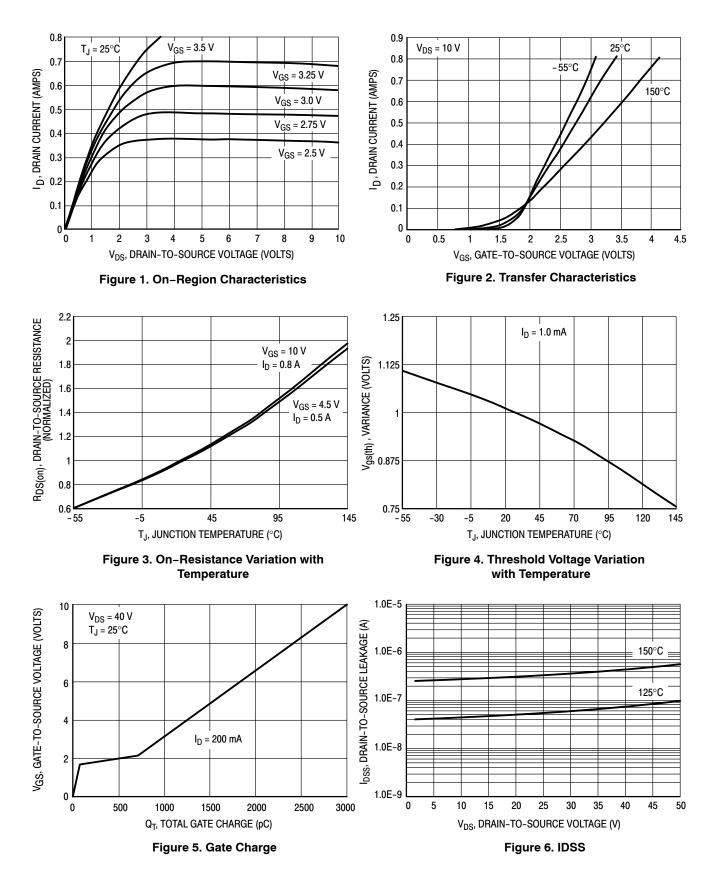
Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperature.

3. ESD between the gate and source serves only, no gate overvoltage rating is implied.





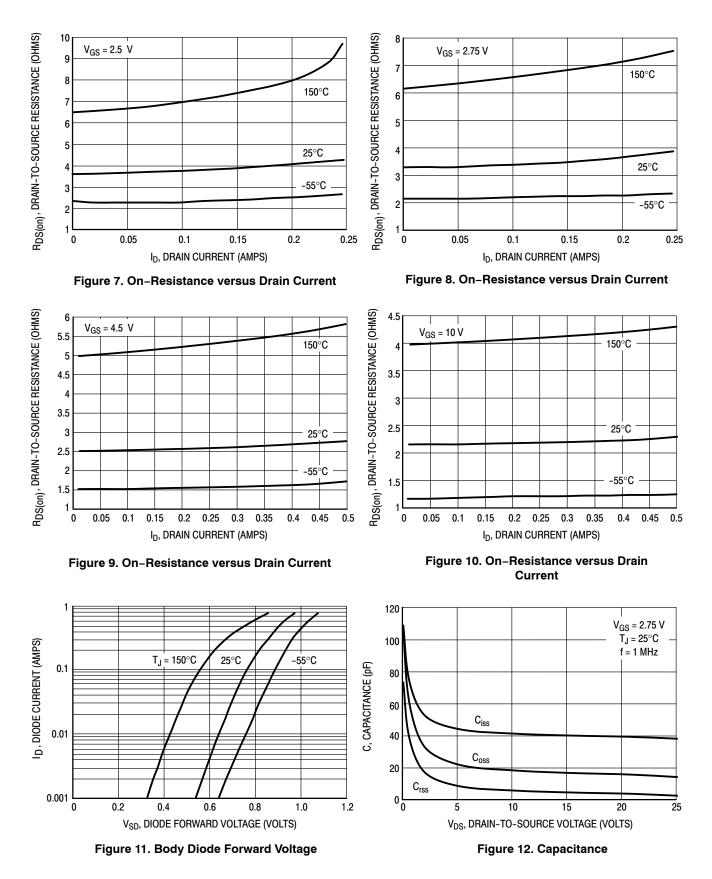
TYPICAL ELECTRICAL CHARACTERISTICS







TYPICAL ELECTRICAL CHARACTERISTICS





TYPICAL ELECTRICAL CHARACTERISTICS

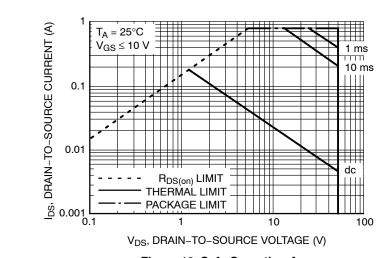


Figure 13. Safe Operating Area



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SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318**

ISSUE AU

DATE 14 AUG 2024













XXX = Specific Device Code М = Date Code

= Pb-Free Package .

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



MILLIMETERS						
DIM	MIN	NOM	МАХ			
А	0.89	1.00	1.11			
A1	0.01	0.06	0.10			
b	0.37	0.44	0.50			
с	0.08	0.14	0.20			
D	2.80	2.90	3.04			
E	1.20	1.30	1.40			
е	1.78	1.90	2.04			
L	0.30	0.43	0.55			
L1	0.35	0.54	0.69			
Ηe	2.10	2.40	2.64			
Т	0°		10°			

NOTES:

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS: 1.

2. MILLIMETERS.

MILLIME IERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE 3.

BASE MATERIAL. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS, OR GATE BURRS.

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE	I	
STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12:	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE	2. CATHODE	2. CATHODE	2. DRAIN	2. GATE
3. CATHODE	3. GATE	3. CATHODE-ANODE	3. ANODE	3. GATE	3. ANODE
STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	I PIN 1. CATHODE	PIN 1. CATHODE
2. CATHODE	2. CATHODE	2. ANODE	2. CATHODE	2. ANODE	2. ANODE
3. ANODE	3. CATHODE	3. CATHODE	3. ANODE	3. CATHODE-ANODE	3. GATE
STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN	PIN 1. ANODE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE
2. SOURCE	2. OUTPUT	2. ANODE	2. DRAIN	2. CATHODE	2. ANODE
3. DRAIN	3. INPUT	3. CATHODE	3. SOURCE	3. GATE	3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE				

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